Projects website: http://StudentEng2016.github.io/

# 1. Structure and Mechanics

Prepared by Adanegbe Amadasun, Alisha Singh Chauham Computer Engineering Technology Student Proposal for the development of FarmBot Februray 05, 2017

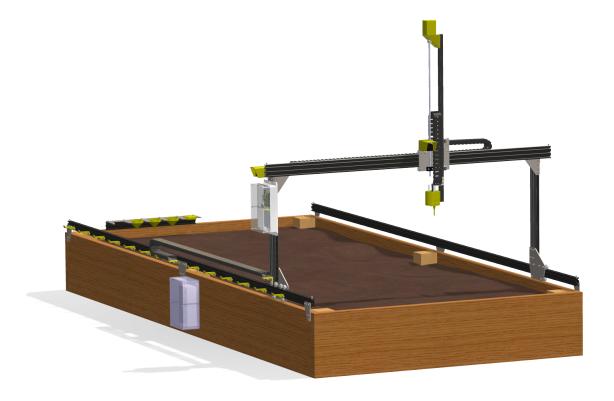


Figure 1:

Image source: (Day, 2016)



Figure 2:

Image source: (Krassenstein, 2014)

Image source: (Inc, 2017)



Figure 3:

# **Executive Summary**

As a student in the Computer Engineering Technology program, we will be integrating the knowledge and skills we have learned from our program into this Internet of Things themed capstone project. This proposal requests the approval to build the hardware portion that will connect to a database as well as to a mobile device application. The internet connected hardware will include a custom PCB with sensors and actuators for an automated farming device. The mobile device functionality will include will include photo sensors, temperature sensors and moisture sensors which will be and will be further detailed in the mobile application proposal. We will be collaborating with the following company/department. In the winter semester I plan to form a group with the Alisha Singh Chauhan who is also building similar hardware this term and working on the mobile application with me. The hardware will be completed in CENG 317 Hardware Production Techniques independently and the application will be completed in CENG 319 Software Project. These will be integrated in CENG 355 Computer Systems Project.

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#### Introduction

FarmBot is going to address some the problems the agricultural industry faces like lost of money, how ineffective some of their equipment are and how they waste resources. FarmBot is going to be more economical and ecofriendly unlike other agricultural equipment being used. It incorporates precision farming, which happens to be a concept based on observing, measuring and responding to inter and intra-field variability in crops. The device is going to be constructed be the FarmBot company, it is going to be made of an Arduino Mega 2650, Raspberry Pi 3, disassembled hardware packages and other software sources. The FarmBot Genesis runs on custom built tracks and other supporting infrastructure which needs to be self assembled. The robot itself relies on a GUI platform which users can access through the FarmBot's web app. The physical robotic system is set in alignment with the crops that are plotted out in the virtual version on the web app. This is how FarmBot can be efficient and reliably distribute water, fertilizer and other elements to keep the plants healthy and striving without minimal wastage. The device is going to be cheaper than convention tools and more efficient.

We have searched for prior art via Humber's IEEE subscription selecting "My Subscribed Content" (Billingsley, Oetomo, & Reid, 2009) and have found and read (Bergerman et al., 2015) which provides insight into similar efforts.

In the Computer Engineering Technology program, we have learned about the following topics from the respective relevant courses:

- Java Docs from CENG 212 Programming Techniques In Java,
- Construction of circuits from CENG 215 Digital And Interfacing Systems,
- Rapid application development and Gantt charts from CENG 216 Intro to Software Engineering,

- Micro computing from CENG 252 Embedded Systems,
- SQL from CENG 254 Database With Java,
- Web access of databases from CENG 256 Internet Scripting; and,
- Wireless protocols such as 802.11 from TECH152 Telecom Networks.

This knowledge and skill set will enable me to build the subsystems and integrate them together as my capstone project.

# **Body**

#### **SRS Document**

### **Purpose**

FarmBot is going to address some the problems the agricultural industry faces like lost of money, how ineffective some of their equipment are and how they waste resources.

#### **Definitions**

An open source automated farming device which operates like a 3D printer. But instead of extruding plastic, its tools are seed injectors, watering nozzles, sensors etc.

## **System Specification**

The hardware component for FarmBot that I have are:

- Raspberry pi 3 It is used to receive data from FarmBot and send it to the Arduino
- Arduino mega 256 It is used to control the bi-polar stepper motor
- Sensor Hat (light and temperature) It is used to receive data about light and temperature from surrounding.
- Bi-polar Stepper motor It controls the movement of the FarmBot

### System overview

FarmBot will be able to perform the following task:

- Monitor the temperature around the plant,
- Provide light to the plant.

## **Database Work Breakdown**

Currently, We only have a local database for our FarmBot project. The database stores the plant number, date, and name locally. Once the app is deleted the users will lose access to all their data.

We plan on getting a server to so all users data can be stored in the cloud and can be accessed by them at any time

# Application and work breakdown

FarmBot is going to be more economical and ecofriendly unlike other agricultural equipment being used. It incorporates precision farming, which happens to be a concept based on observing, measuring and responding to inter and intra-field variability in crops. The device is going to be constructed be the FarmBot company, it is going to be made of an Arduino Mega 2650, Raspberry Pi 3, Sensor hat (which can read temperature, light, and soil condition), and Bi-polar stepper motor.

We plan on first tightening a pulley to my bi-polar, then create a pulley system with the motor and a case.

#### Web and work breakdown

An app was created to use for the FarmBot, this app would be used to control the FarmBot to plant seed at desire position in the bed. Also, the user can choose the option of giving the FarmBot light for a duration of time, watering the plant etc.

After installing the app on your mobile phone, users will be prompt to create an account by choosing user name and password. This will then give them access to their FarmBot and its data stored in the cloud.

The user can then pick the seed of the crop they want to plant, and the care option they want to apply to the seed (i.e. The light duration, or how frequently they want to water the plant) and submit the options they picked

The user would be given the access to control the FarmBot and apply the option picked from the previous screen.

We plan on connecting FarmBot's app with raspberry pi, so that users can be able to send data to it.

## Methodology

This proposal is assigned in the first week of class and is due at the beginning of class in the second week of the fall semester. My coursework will focus on the first two of the 3 phases of this project:

Phase 1 Hardware build.

Phase 2 System integration.

Phase 3 Demonstration to future employers.

Phase 1 Hardware build

The hardware build will be completed in the fall term. It will fit within the CENG Project maximum dimensions of  $12\ 13/16$ " x 6" x  $2\ 7/8$ " (32.5cm x 15.25cm x 7.25cm) which represents the space below the tray in the parts kit. The highest AC voltage that will be used is 16Vrms from a wall adaptor from which  $+/-\ 15$ V or as high as  $45\ \text{VDC}$  can be obtained. Maximum power consumption will be 20 Watts.

Phase 2 System integration

The system integration will be completed in the fall term.

Phase 3 Demonstration to future employers

This project will showcase the knowledge and skills that we have learned to potential employers.

The tables below provide rough effort and non-labour estimates respectively for each phase. A Gantt chart will be added by week 3 to provide more project schedule details and a more complete budget will be added by week 4. It is important to start tasks as soon as possible to be able to meet deadlines.

Labour Estimates	Hrs	Notes
Phase 1		
Writing proposal.	9	Tech identification quiz.
Creating project schedule. Initial project team meeting.	9	Proposal due.
Creating budget. Status Meeting.	9	Project Schedule due.
Acquiring components and writing progress report.	9	Budget due.
Mechanical assembly and writing progress report. Status Meeting.	9	Progress Report due (components acquired milestone).
PCB fabrication.	9	Progress Report due (Mechanical Assembly milestone).
Interface wiring, Placard design, Status Meeting.	9	PCB Due (power up milestone).
Preparing for demonstration.	9	Placard due.
Writing progress report and demonstrating project.	9	Progress Report due (Demonstrations at Open House Saturday, November 7, 2015 from 10 a.m 2 p.m.).
Editing build video.	9	Peer grading of demonstrations due.

Incorporation of feedback from	9	30 second build video due.
demonstration and writing progress		
report. Status Meeting.		
Practice presentations	9	Progress Report due.
1st round of Presentations, Collaborators	9	Presentation PowerPoint file due.
present.		
2nd round of Presentations	9	Build instructions up due.
Project videos, Status Meeting.	9	30 second script due.
Phase 1 Total	135	
Phase 2		
Meet with collaborators	9	Status Meeting
Initial integration.	9	Progress Report
Meet with collaborators	9	Status Meeting
Testing.	9	Progress Report
Meet with collaborators	9	Status Meeting
Meet with collaborators	9	Status Meeting
Incorporation of feedback.	9	Progress Report
Meet with collaborators	9	Status Meeting
Testing.	9	Progress Report
Meet with collaborators	9	Status Meeting
Prepare for demonstration.	9	Progress Report
Complete presentation.	9	Demonstration at Open House Saturday,
		April 9, 2016 10 a.m. to 2 p.m.
Complete final report. 1st round of	9	Presentation PowerPoint file due.
Presentations.		
Write video script. 2nd round of	9	Final written report including final budget
Presentations, delivery of project.		and record of expenditures, covering both
		this semester and the previous semester.
Project videos.	9	Video script due
Phase 2 Total	9 <b>135</b>	Video script due
Phase 2 Total Phase 3	135	Video script due
Phase 2 Total Phase 3 Interviews	<b>135</b> TBD	Video script due
Phase 2 Total Phase 3 Interviews Phase 3 Total	135 TBD <b>TBD</b>	
Phase 2 Total Phase 3 Interviews Phase 3 Total Material Estimates	<b>135</b> TBD	Video script due  Notes
Phase 2 Total Phase 3 Interviews Phase 3 Total Material Estimates Phase 1	TBD TBD Cost	Notes
Phase 2 Total Phase 3 Interviews Phase 3 Total Material Estimates Phase 1 A microcomputer composed of a	135 TBD <b>TBD</b>	
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Phase 3 Interviews Phase 3 Total Material Estimates Phase 1 A microcomputer composed of a quad-core Windows 10 IoT core compatible Broadcom BCM2836 SoC with a 900MHz Application ARM Cortex-A7 32 bit RISC v7-A processor core stacked under 1GB of 450MHz SDRAM, 10/100 Mbit/s Ethernet, GPIO, UART, I2C bus, SPI bus, 8 GB of Secure Digital storage, a power supply, and a USB Wi-Fi adaptor. Peripherals with cables Sensors Actuators Hardware, etc. Phase 1 Total  Phase 2 Materials to improve functionality, fit, and finish of project. Phase 2 Total Phase 3 Off campus colocation	TBD TBD Cost >\$80.00  TBD <\$100.00	Notes  An example of a retailer: [3].
Phase 3 Interviews Phase 3 Total Material Estimates Phase 1 A microcomputer composed of a quad-core Windows 10 IoT core compatible Broadcom BCM2836 SoC with a 900MHz Application ARM Cortex-A7 32 bit RISC v7-A processor core stacked under 1GB of 450MHz SDRAM, 10/100 Mbit/s Ethernet, GPIO, UART, I2C bus, SPI bus, 8 GB of Secure Digital storage, a power supply, and a USB Wi-Fi adaptor. Peripherals with cables Sensors Actuators Hardware, etc. Phase 1 Total  Phase 2 Materials to improve functionality, fit, and finish of project. Phase 2 Total Phase 3	TBD TBD Cost >\$80.00	Notes  An example of a retailer: [3].

Phase 3 Total	TBD
Duty	TBD
Tax	TBD

## **Concluding remarks**

This proposal presents a plan for providing an IoT solution for FarmBot This is an opportunity to integrate the knowledge and skills developed in our program to create a collaborative IoT capstone project demonstrating my ability to learn how to support projects. We request the approval of this project.

#### References

These are the references We am going to use for the duration of this project, though if we come across other references we will add them.

(Billingsley et al., 2009)

(Bergerman et al., 2015)

(Corporation, 2017)

(Inc, 2017)

(Day, 2016)

(Krassenstein, 2014)

Bergerman, M., Maeta, S. M., Zhang, J., Freitas, G. M., Hamner, B., Singh, S., & Kantor, G. (2015). Robot farmers: Autonomous orchard vehicles help tree fruit production. *IEEE Robotics Automation Magazine*, 22(1), 54–63. https://doi.org/10.1109/MRA.2014.2369292

Billingsley, J., Oetomo, D., & Reid, J. (2009). Agricultural robotics [tC spotlight]. *IEEE Robotics Automation Magazine*, *16*(4), 16–16, 19. https://doi.org/10.1109/MRA.2009.934829

Corporation, C. (2017). Raspberry pi 3 complete starter kit - 32 gB edition. Retrieved from https://www.canakit.com/raspberry-pi-3-starter-kit.html

Day, S. (2016). Farmbot: The robot to grow your garden with ease. Retrieved from http://www.directcannabisnetwork.com/farmbot-the-robot-to-grow-your-garden-with-ease/

Inc, F. (2017). Interchangeable tooling. Retrieved from https://farmbot.io/

Krassenstein, E. (2014). FarmBot: An open source 3D farming printer that aims to create food for everyone. Retrieved from https://3dprint.com/12325/farmbot-3d-farming-printer/